

DATASHEET

Product Name **Low T.C.R Thick Film Chip Resistors**

Part Name **LT Series**

File No. **SMD-SP-008**

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1. Scope

- 1.1 This datasheet is the characteristics of Low T.C.R Thick Film Chip Resistors manufactured by UNI-ROYAL.
- 1.2 Low T.C.R $\pm 50\text{PPM}/^\circ\text{C}$
- 1.3 Suitable for reflow & wave soldering
- 1.4 Application precision medical equipment, Auto industrial control system, Communication equipment, IPAD, Portable computer, LED lamps, intelligent home appliances.
- 1.5 AEC-Q200 qualified.
- 1.6 Compliant with RoHS directive.
- 1.7 Halogen free requirement.

2. Part No. System

Part No. includes 14 codes shown as below:

2.1 1st~4th codes: Part name. E.g.: LT02、LT03、LT05、LT06

2.2 5th~6th codes: Power rating.

E.g.: W=Normal Size “1~G” = “1~16”

Wattage	1/4	1/8	1/10	1/16
Normal Size	W4	W8	WA	WG

If power rating is equal or lower than 1 watt, 5th code would be “W” and 6th code would be a number or letter.

E.g.: WA=1/10W W4=1/4W

2.3 7th code: Tolerance. E.g.: C= $\pm 0.25\%$ D= $\pm 0.5\%$ F= $\pm 1\%$

2.4 8th~11th codes: Resistance Value.

2.4.1 If value belongs to standard value of E-24 series, the 8th code is zero, 9th~10th codes are the significant figures of resistance value, and the 11th code is the power of ten.

2.4.2 If value belongs to standard value of E-96 series, the 8th~10th codes are the significant figures of resistance value, and the 11th code is the power of ten.

2.4.3 11th codes listed as following:

0= 10^0 1= 10^1 2= 10^2 3= 10^3 4= 10^4 5= 10^5 6= 10^6 J= 10^{-1} K= 10^{-2} L= 10^{-3} M= 10^{-4}

2.5 12th~14th codes.

2.5.1 12th code: Packaging Type. E.g.: T=Tape/Reel

2.5.2 13th code: Standard Packing Quantity.

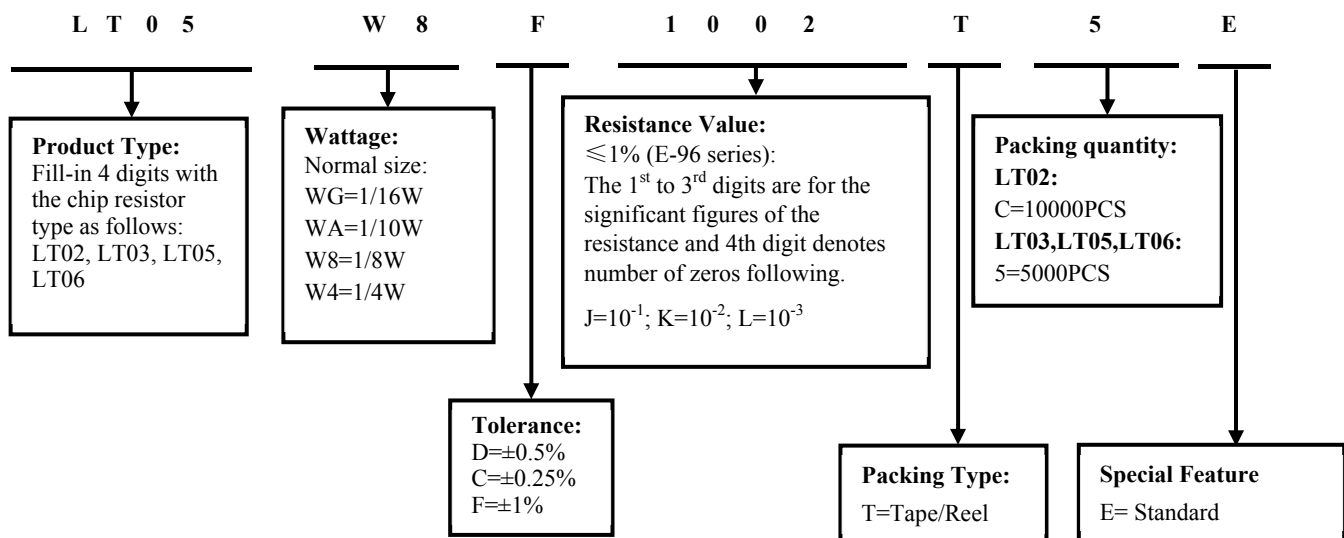
5=5,000pcs

2.5.3 14th code: Special features.

E = Standard.

3. Ordering Procedure

(Example: LT05 1/8W $\pm 1\%$ 10K Ω T/R-5000)



4. Marking

4.1 For LT02 size. Due to the very small size of the resistor's body, there is no marking on the body.



4.1 $\pm 1\%$ tolerance products (E-96 series):

4 codes.

1st~3rd codes are the significant figures of resistance value, and the rest code is the power of ten.

Letter "R" in mark means decimal point.



2701 $\rightarrow$ 2.7K Ω

4.2 Standard E-96 series values of LT03 $\leq \pm 1\%$: due to the small size of the resistor's body, 3 digits marking will be used to indicate the accurate resistance value by using the following multiplier & resistance code.

Multiplier Code (for LT03 $\leq \pm 1\%$ marking)

Code	A	B	C	D	E	F	G	H	X	Y	Z
Multiplier	10^0	10^1	10^2	10^3	10^4	10^5	10^6	10^7	10^{-1}	10^{-2}	10^{-3}

Standard E-96 series Resistance Value code (for LT03 $\leq \pm 1\%$ marking)

Value	Code	Value	Code	Value	Code	Value	Code
100	01	178	25	316	49	562	73
102	02	182	26	324	50	576	74
105	03	187	27	332	51	590	75
107	04	191	28	340	52	604	76
110	05	196	29	348	53	619	77
113	06	200	30	357	54	634	78
115	07	205	31	365	55	649	79
118	08	210	32	374	56	665	80
121	09	215	33	383	57	681	81
124	10	221	34	392	58	698	82
127	11	226	35	402	59	715	83
130	12	232	36	412	60	732	84
133	13	237	37	422	61	750	85
137	14	243	38	432	62	768	86
140	15	249	39	442	63	787	87
143	16	255	40	453	64	806	88
147	17	261	41	464	65	825	89
150	18	267	42	475	66	845	90
154	19	274	43	487	67	866	91
158	20	280	44	499	68	887	92
162	21	287	45	511	69	909	93
165	22	294	46	523	70	931	94
169	23	301	47	536	71	953	95
174	24	309	48	549	72	976	96

So the resistance value are marked as the following examples



1.96K Ω =196 $\times 10^1\Omega$ =29B



12.4 Ω =124 $\times 10^{-1}\Omega$ =10X

4.3 Standard E-24 and not belong to E-96 series values ($\leq \pm 1\%$) of LT03 size: the marking is the same as 5% tolerance but marking as underline.



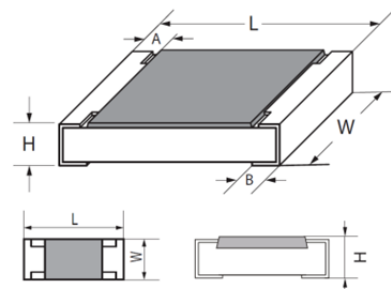
333=33K Ω



680=68 Ω

5. Dimension

Type	Dimension(mm)				
	L	W	H	A	B
LT02(0402)	1.00±0.10	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
LT03(0603)	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20
LT05(0805)	2.00±0.15	1.25±0.15/-0.10	0.55±0.10	0.40±0.20	0.40±0.20
LT06(1206)	3.10±0.15	1.55±0.15/-0.10	0.55±0.10	0.45±0.20	0.45±0.20



6. Resistance Range

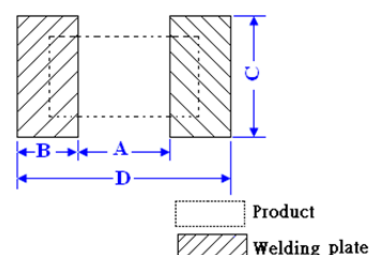
Type	Power Rating	Resistance Range		
		0.25%	0.5%	1.0%
LT02	1/16W	100Ω-1MΩ	100Ω-1MΩ	100Ω-1MΩ
LT03	1/10W	1Ω-1MΩ	1Ω-1MΩ	1Ω-1MΩ
LT05	1/8W	1Ω-1MΩ	1Ω-1MΩ	1Ω-1MΩ
LT06	1/4W	1Ω-1MΩ	1Ω-1MΩ	1Ω-1MΩ

7. Ratings:

Type	Max. Working Voltage	Max. Overload Voltage	Dielectric withstanding Voltage	Operating Temperature
LT02	50V	100V	100V	-55~+155℃
LT03	75V	150V	300V	-55℃~155℃
LT05	150V	300V	500V	-55℃~155℃
LT06	200V	400V	500V	-55℃~155℃

8. Soldering pad size recommended

Type	Dimension(mm)			
	A	B	C	D
LT02	0.50±0.05	0.45±0.05	0.5±0.05	1.4±0.05
LT03	0.8±0.05	0.65±0.05	0.8±0.05	2.1±0.05
LT05	1.0±0.1	1.0±0.1	1.3±0.1	3.0±0.1
LT06	2.0±0.1	1.2±0.1	1.6±0.1	4.4±0.1



9. Derating Curve:

Power rating will change based on continuous load at ambient temperature from -55 to 155℃. It is constant between -55 to 70℃, and derate to zero when temperature rise from 70 to 155℃.

Voltage rating:

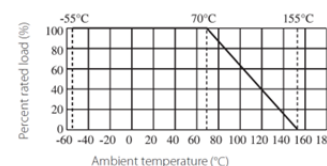
Resistors shall have a rated direct-current (DC) continuous working voltage or an approximate sine-wave root-mean-square (RMS) alternating-current (AC) continuous working voltage at commercial-line frequency and waveform corresponding to the power rating, as determined from the following formula:

$$RCWV = \sqrt{P \times R}$$

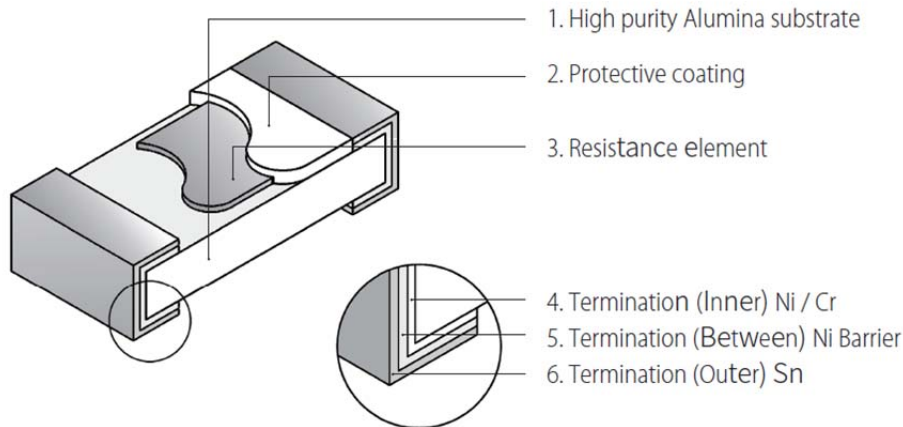
Remark: RCWV: Rating Continuous Working Voltage (Volt.) P: power rating (Watt) R: nominal resistance (Ω)

In no case shall the rated DC or RMS AC continuous working voltage be greater than the applicable maximum value.

The overload voltage is 2.5 times RCWV or Max. Overload voltage whichever is lower.



10. Structure



11. Performance Specification

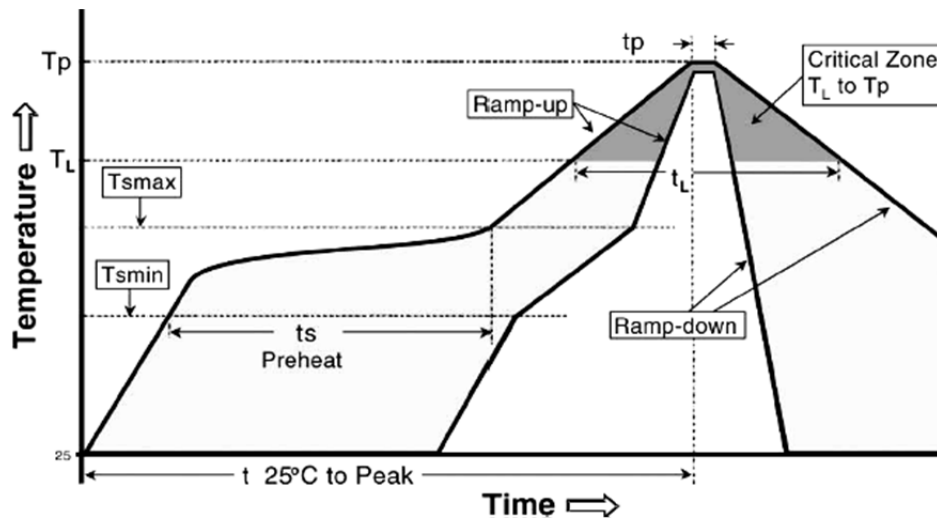
Characteristic	Limits	Ref. Standards	Test Methods
Operational life	$\pm(1.0\%+0.05\Omega)$	MIL-STD-202	70°C rated power , at RCWV or Max .Working Voltage whichever less, 1000h (1.5 hours “ON”, 0.5 hour “OFF”). Measurement at 24±4hours after test conclusion.
Electrical Characterization (T.C.R)	LT02: $\pm 50\text{ppm}/^\circ\text{C}$ LT03: $1\Omega \leq R \leq 10\Omega$: $\pm 100\text{ppm}/^\circ\text{C}$ $10\Omega < R \leq 1\text{M}\Omega$: $\pm 50\text{ppm}/^\circ\text{C}$ LT05: $1\Omega \leq R \leq 10\Omega$: $\pm 100\text{ppm}/^\circ\text{C}$ $10\Omega < R \leq 1\text{M}\Omega$: $\pm 50\text{ppm}/^\circ\text{C}$ LT06: $1\Omega \leq R \leq 10\Omega$: $\pm 100\text{ppm}/^\circ\text{C}$ $10\Omega < R \leq 1\text{M}\Omega$: $\pm 50\text{ppm}/^\circ\text{C}$	GB/T 5729 4.8 JIS-C-5201 4.8 IEC 60115-1 6.2	Natural resistance changes per temp. Degree centigrade $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (PPM}/^\circ\text{C)}$ R ₁ : Resistance Value at room temperature (t ₁) ; R ₂ : Resistance at test temperature (t ₂) t ₁ : +25°C or specified room temperature t ₂ : Test temperature (-55°C or 125°C)
Short-time overload	$\pm(1.0\%+0.05\Omega)$	GB/T 5729 4.13 JIS-C-5201 4.13 IEC 60115-1 8.1.4.2	Permanent resistance change after the application of a potential of 2.5 times RCWV or Max. Overload Voltage whichever less for 5 seconds..
External Visual	Marking Complete , no mechanical damage	MIL-STD-883 Method 2009	Electrical test not required. Inspect device construction, marking and workmanship
Physical Dimension	Reference 5 Dimension Standards	JESD22 MH Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical test not required.
Resistance to Solvent	Marking Complete , no mechanical damage	MIL-STD-202 Method 215	Note: Add Aqueous wash chemical – OKEM Clean or equivalent. Do not use banned solvents.
Terminal Strength	Not broken	AEC-Q200-0069	LT02:5N; others:17.7N, 60±1 seconds.
High Temperature Exposure (Storage)	$\pm(1.0\%+0.05\Omega)$	MIL-STD-202 Method 108	Upper Temperature. 1000hrs.Unpowered. Measurement at 24±4 hours after test conclusion.
Temperature Cycling	$\pm(1.0\%+0.05\Omega)$	JESD22 Method JA-104	1000 Cycles (-55°C to +155°C). Measurement at 24±4 hours after test conclusion.
Biased Humidity	$\pm(1.0\%+0.05\Omega)$	MIL-STD-202 Method 103	1000 hours 85°C,85%RH. Note: Specified conditions: 10% of operating power. Measurement at 24±4 hours after test conclusion.

Mechanical Shock	$\pm(1.0\%+0.05\Omega)$	MIL-STD-202 Method 213	Half sine wave, acceleration 100g's, each three times in X, Y and Z directions, pulse width 6ms.
Vibration	$\pm(1.0\%+0.05\Omega)$	MIL-STD-202 Method 204	5g's for 20 min., 12cycle each of 3 orientations. Note: Use 8"*5"PCB. 031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2' from any secure point. Test from 10-2000Hz.
ESD	$\pm(3.0\%+0.05\Omega)$	AEC-Q200-002	With the electrometer in direct contact with the discharge tip, verify the voltage setting at levels of $\pm 500V, \pm 1KV, \pm 2KV, \pm 4KV, \pm 8KV$, The electrometer reading shall be within $\pm 10\%$ for voltages from 500V to $\leq 800V$.
Solderability	Coverage must be over 95%.	J-STD-002	For both leaded & SMD. Electrical test not required. Magnification 50X. Conditions: a) Method B 4hrs at 155°C dry heat, the dip in bath with $245\pm 3^\circ C, 5\pm 0.5s$. b) Method D: at $260\pm 3^\circ C, 30\pm 0.5s$.
Flammability	No ignition of the tissue paper or scorching or the pinewood board	UL-94	V-0 or V-1 are acceptable. Electrical test not required.
Board Flex	$\pm(1.0\%+0.05\Omega)$	AEC-Q200-005	Bending 2mm(min) for 60+5sec
Flame Retardance	No flame	AEC-Q200-001	Only requested, when voltage/power will increase the surface temp to 350°C. Apply voltage from 9V to 32V. No flame; No explosion.
Resistance to Soldering Heat	$\pm(1.0\%+0.05\Omega)$	MIL-STD-202 Method 210	Condition B No per-heat of samples. Dipping the resistor into a solder bath having a temperature of $260^\circ C \pm 5^\circ C$ and hold it for 10 ± 1 seconds

12. Soldering Condition

(This is for recommendation, please customer perform adjustment according to actual application)

12.1 Recommend Reflow Soldering Profile : (solder : Sn96.5 / Ag3 / Cu0.5)

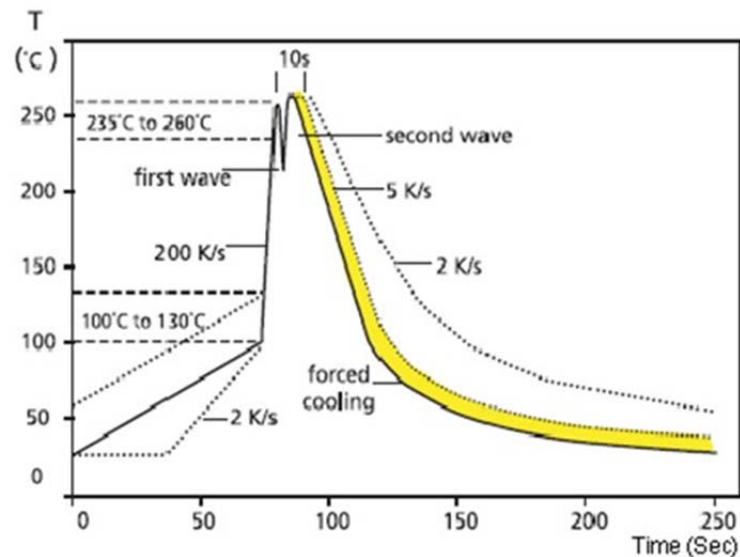


Profile Feature	Lead (Pb)-Free solder
Preheat: Temperature Min (T_{smin}) Temperature Max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	150°C 200°C 60 -120 seconds
Average ramp-up rate: (T_{smax} to T_p)	3°C / second max.
Time maintained above : Temperature (T_L) Time (t_L)	217°C 60-150 seconds
Peak Temperature (T_p)	260°C
Time within $+0_{-5}^{\circ}\text{C}$ of actual peak Temperature (t_p) ²	10 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8minutes max.

Allowed Re-flow times : 2 times

Remark : To avoid discoloration phenomena of chip on terminal electrodes, we suggest use N2 Re-flow furnace .

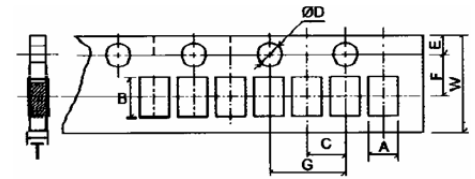
12.2 Recommend Wave Soldering Profile : (Apply to 0603 and above size)



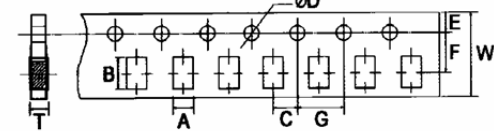
13. Packing of Surface Mount Resistors

13.1 Taping Dimension : (Unit: mm)

Type	A ±0.1	B ±0.1	C ±0.05	$\Phi D^{+0.1}_{-0}$	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.05
LT02	0.65	1.20	2.00	1.50	1.75	3.50	4.00	8.00	0.42

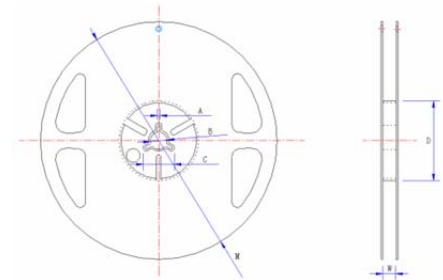


Type	A ±0.2	B ±0.2	C ±0.05	$\Phi D^{+0.1}_{-0}$	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.1
LT03	1.10	1.90	2.00	1.50	1.75	3.50	4.00	8.00	0.67
LT05	1.65	2.40	2.00	1.50	1.75	3.50	4.00	8.00	0.81
LT06	2.00	3.60	2.00	1.50	1.75	3.50	4.00	8.00	0.81



13.2 Dimension of Reel : (Unit: mm)

Type	Taping	Qty/Reel	A±0.5	B±0.5	C±0.5	D±1	M±2	W±1
LT02	Paper	10,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
LT03	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
LT05	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
LT06	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0



14. Note

14.1. UNI-ROYAL recommend products store in warehouse with temperature between 15 to 35°C under humidity between 25 to 75%RH.

Even under storage conditions recommended above, solder ability of products will be degraded stored over 1 year old.

14.2. Cartons must be placed in correct direction which indicated on carton, otherwise the reel or wire will be deformed.

14.3. Storage conditions as below are inappropriate:

- Stored in high electrostatic environment
- Stored in direct sunshine, rain, snow or condensation.
- Exposed to sea wind or corrosive gases, such as Cl₂, H₂S, NH₃, SO₂, NO₂, Br etc.

15. Record

Version	Description	Page	Date	Amended by	Checked by
1	First version	1~8	Dec.09, 2022	Haiyan Chen	Yuhua Xu
2	Modify ESD test	6	Feb.19, 2024	Song Nie	Haiyan Chen
3	Modify Performance Specification	5	Jan.08, 2026	Xiaoli Liu	Haiyan Chen

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